

Datasheet Revision: 1, Revision Date: May 31, 2022

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Yes

## Solder Core Wire No-Clean Lead-Free

## Product Highlights No-Clean Synthetic Flux Core The clear, non-corrosive, non-conductive residue is meant to be left on the board. 2.0% flux core Halogen content: None RoHS 3 and REACH compliant

## **Specifications**

Alloy:	Sn96.5/Ag3.0/Cu0.5
Available Wire Diameters:	0.031" (0.78mm), 0.020" (0.50mm) & 0.015" (0.38mm)
Flux Type:	No-Clean Synthetic
Flux Classification:	ROL0
Melting Point:	217-220°C (423-428°F)
Packaging:	1 lb spools

Orderable Part Numbers HMT-NC-SWLF.015-1LB HMT-NC-SWLF.020-1LB HMT-NC-SWLF.031-1LB

## **Test Results**

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Test J-STD-004 or other requirements as stated	Test Requirement	Result
Copper Mirror	IPC-TM-650: 2.3.32	L: No breakthrough
Corrosion	IPC-TM-650: 2.6.15	L: No corrosion
Quantitative Halides	IPC-TM-650: 2.3.28.1	L: <0.5%
Electrochemical Migration	IPC-TM-650: 2.6.14.1	L: <1 decade drop (No-clean)
Surface Insulation Resistance 40°C, 90% RH @ 168 Hours	IPC-TM-650: 2.6.3.7	L: ≥100MΩ (No-clean)
Visual	IPC-TM-650: 3.4.2.5	Clear and free from precipitation
Conflict Minerals Compliance	Electronic Industry Citizenship Coalition (EICC)	Compliant
REACH Compliance	Articles 33 and 67 of Regulation (EC) No 1907/2006	Contains no substance >0.1% w/w that is listed as a SVHC or restricted for use in solder materials

Conforms to the following Industry Standards:

J-STD-004B, Amendment 1 (Solder Fluxes):

	100
J-STD-006C, Amendments 1 & 2 (Solder Alloys and Fluxed/Non-Fluxed Solders):	Yes
RoHS 3 Directive (EU) 2015/863:	

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